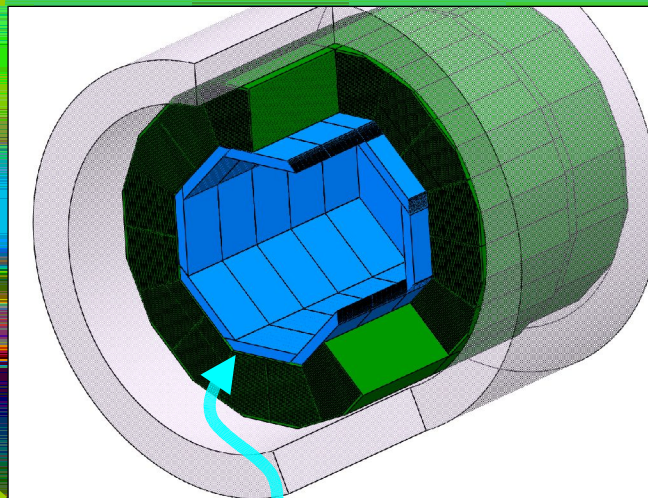


R & D on silicon tungsten **ECAL**

CALICE ECAL Groups

presented by Henri Videau

LLR



ECAL

Just trying to tell you that we hope we know what we are trying to do

A development of ECAL technology by stages

- Understanding the physics and the simulation and approach the technologies to identify possible show stoppers. **Physics prototype**

- Then develop the different technologies, including software adequate for ILC detectors

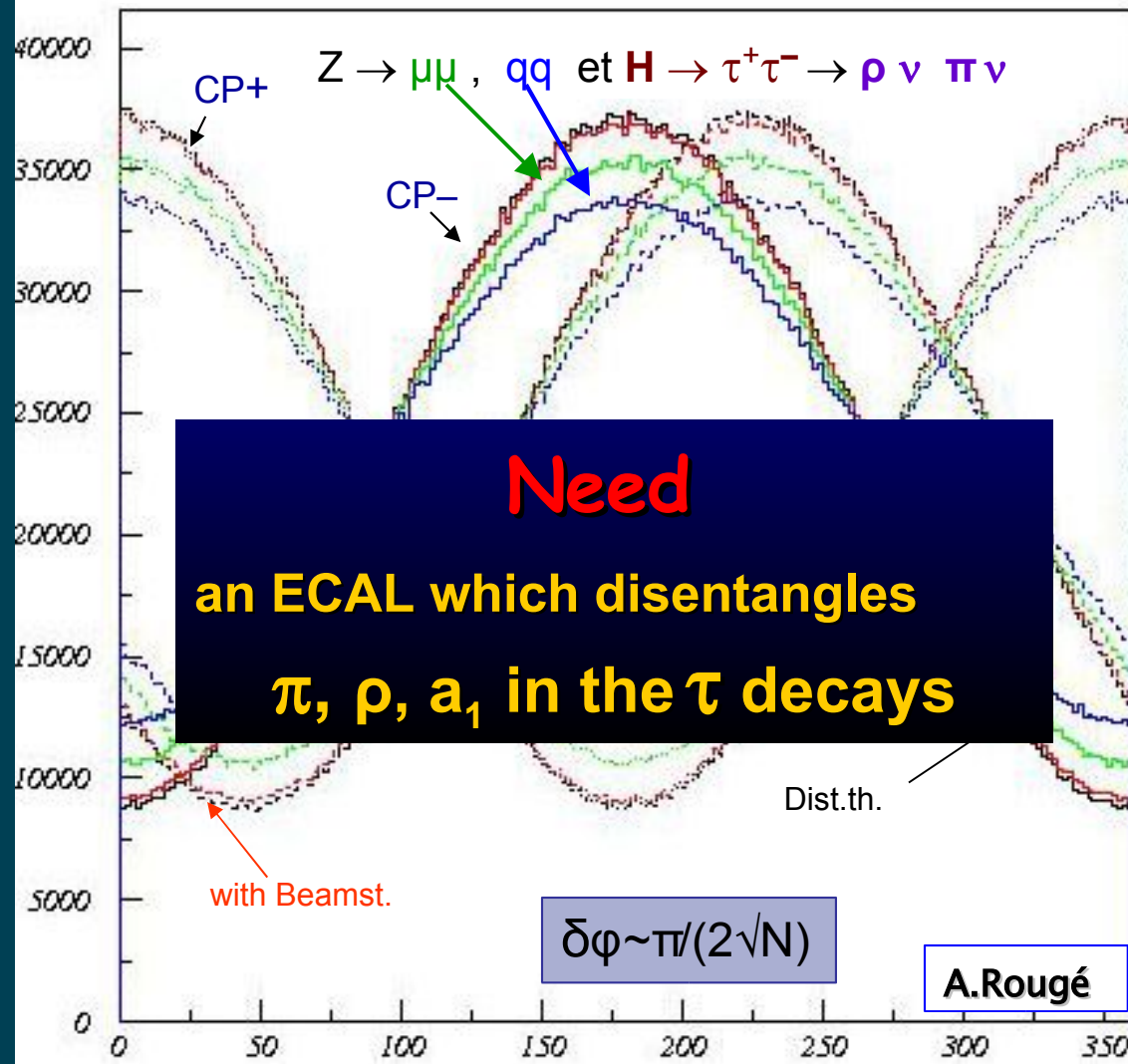
Technological prototypes

We do not do R&D merely for fun along flowing years but try to address in a coherent and rigorous mind what we think are the ILC calorimetry challenges.

In addition to PFA for jets

Direct impact on ECAL

CP violation, Higgs sector

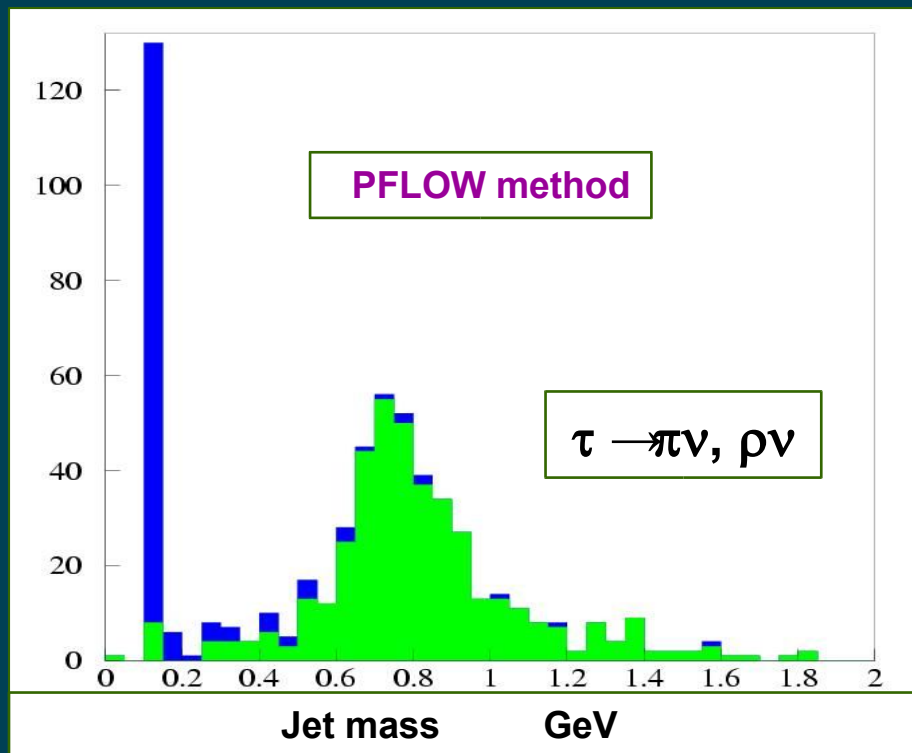


$e^+ e^- \rightarrow ZH$

$\rho \rightarrow \pi^+ \pi^0$
($\pi^0 \rightarrow \gamma \gamma$)

CP angle analyser

This PFLOW method allows to analyse the Taus decays
Which are an excellent polarization analyzer



Doing Higgs physics with taus.

	Jet mass < 0.2	Jet mass in 0.2-2
$\tau \rightarrow \pi\nu$	82%	17%
$\tau \rightarrow \rho\nu$	2%	90%

We want a **calorimeter** with

- A good separation between close showers **PFLOW**
- A **QUASI Perfect efficiency** to find photons in jet **PFLOW**
- A **QUASI Perfect efficiency** to find neutral hadrons in jet **PFLOW**
- A good separability e/π
- A good reconstruction of photon direction (GMSB, long life particle), **ECAL requir.**
- An **ECAL** which allows analysing the tau decays

Together with a detector

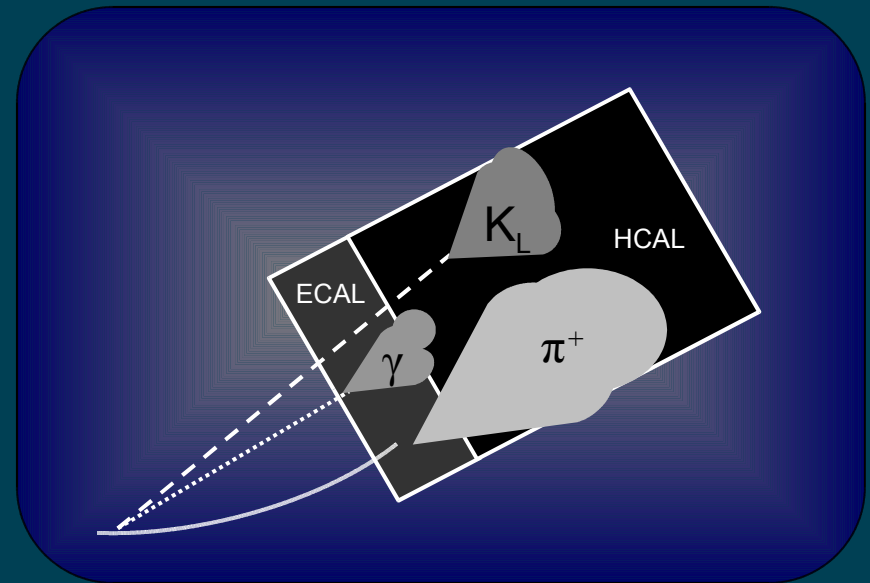
- as compact as possible (cost and feasibility of the magnet)
- Running in a B-field from 3 to 5 T (imposed by background)
- A running stable with time, temperature, noise from machine,...

Separation and reconstruction
are more important than
the energy resolution itself

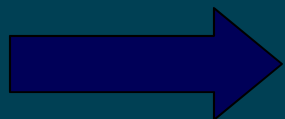
To summarize

Optimising the performances
on the « particle flow »

Granularity and resolution on
direction/energy of the jets



Resolution on the jets δE_{jet}	2-3 better than LHC
Granularity/segmentation of the calorimeter	>10²⁻³ x LHC



Specific R&D mandatory

The proposed solutions

ECAL : Sampling calorimeter

Solution 1 :

tungsten (density) – **silicon** (pixel size \ll Molière radius)

Pixels size $< 1 \text{ cm}^2$ and about 20–30 readout layers
(15 to 250 Millions channels)

or **silicon** (pixel size \sim Mip density in showers)

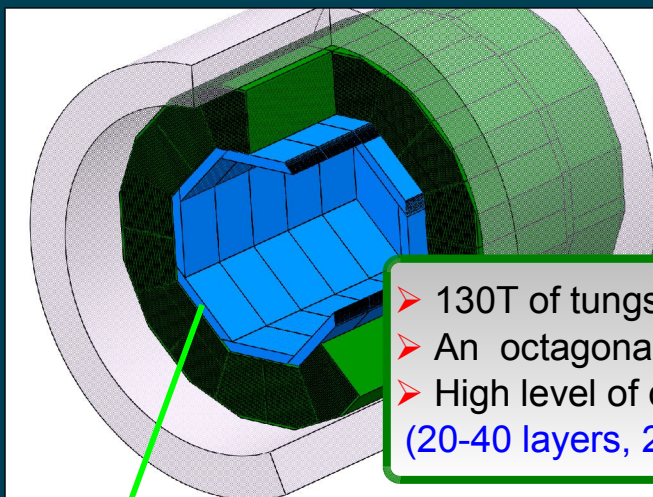
Pixels size $\sim 50 \times 50 \text{ } \mu\text{m}^2$
(Tera Pixel Calorimeter)

Solution 2 :

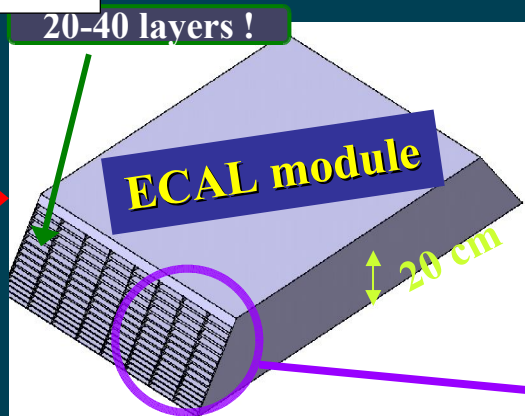
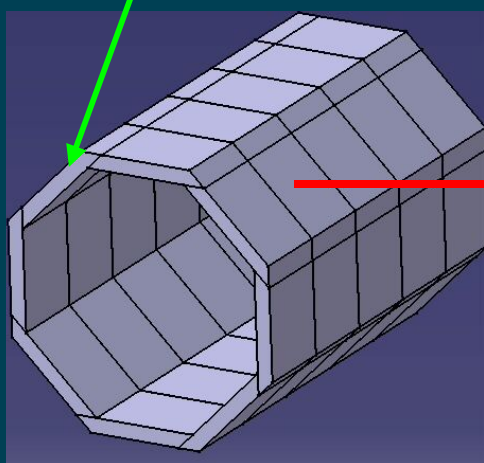
tungsten – MPPC and scintillator strip

Scint. Strip $1 \times 4\text{--}5 \text{ cm X, Y}$ and about 30 readout layers
(about 10 Millions channels)

The Silicon Tungsten electromagnetic calorimeter



- 130T of tungsten
- An octagonal geometry
- High level of density (20-40 layers, 24X0 in ~170mm)



- No large area of dead zone
- All modules are identical (Tungsten wrapped by Cfi)
- The detector slabs would be tested before assembling

CALICE - W-Si ECAL



Ewha Univ., Sungyunkwan Univ.,
Kangnung NU, Yonsei Univ.



LAL, LLR, LPC-Ct, LPSC, PICM



BARC-Mumbai



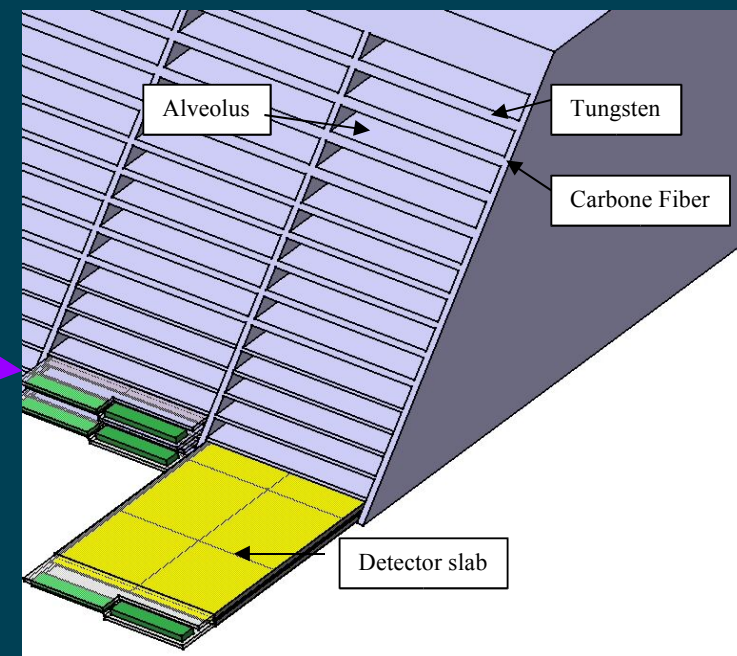
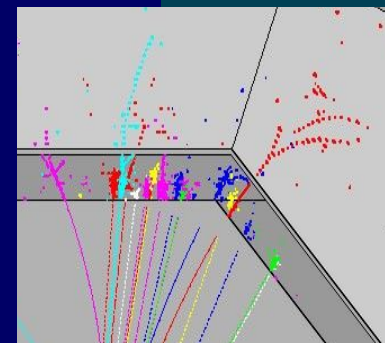
ITEP, IHEP, MSU



Prague (IOP-ASCR)



Imp. Coll, UCL, Cambridge, Birmingham,
Manchester, RAL, RHUL



- ❑ **Small Molière radius** \Rightarrow small thickness for non-W material (15mm)
- ❑ **Threshold $< m_{\pi}$** \Rightarrow large mip signal \Rightarrow wafer not too thin (300 μ m)
- ❑ **S/N at mip > 10** \Rightarrow small noise
- ❑ **Weak coherent noise** \Rightarrow pick-up, ground, power supply etc...
- ❑ **Large dynamic (16bits)** \Rightarrow multi preamp ?? , shaper multigains
- ❑ **Weak power dissipation** (electronics) \Rightarrow power cycling
- ❑ **Behaviour of the VFE chip when 500–600 GeV em shower goes through**
- ❑ For WSi Keep under control the silicon cost \Rightarrow labos in contact with private companies

DETECTOR MATRICES

Relatively crude object when compared to a microstrip of pixels VDET

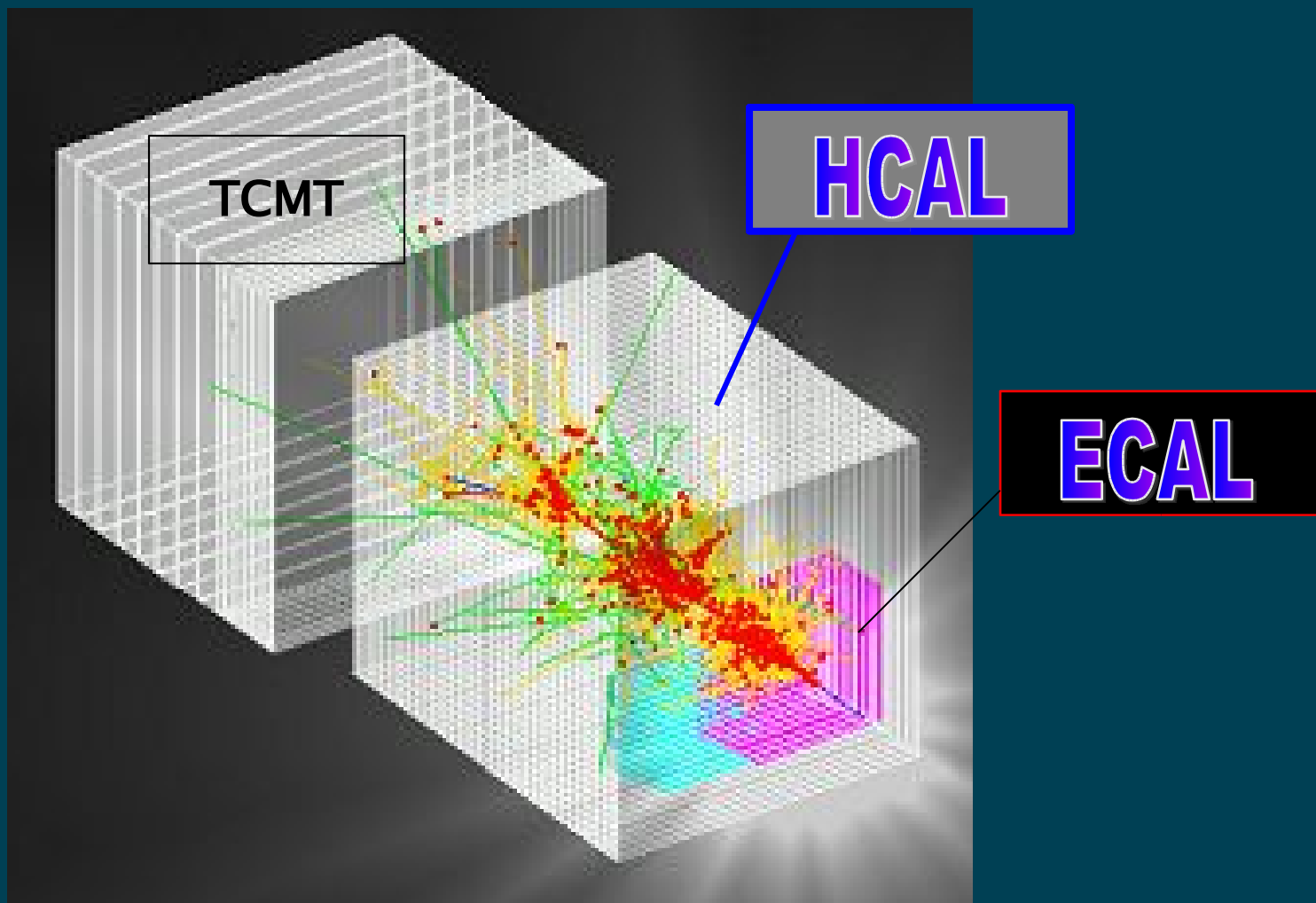
- ♦ **Number of mask** $\sim 4-5$
- ♦ **Industrial yield** $\sim 80\%$
- ♦ **Use of large wafers** 6 or 8" ?

The goal is

$< 2 \text{ \$/cm}^2$

For the 2006 RDR cost estimation of the detector, 3\$ have been used

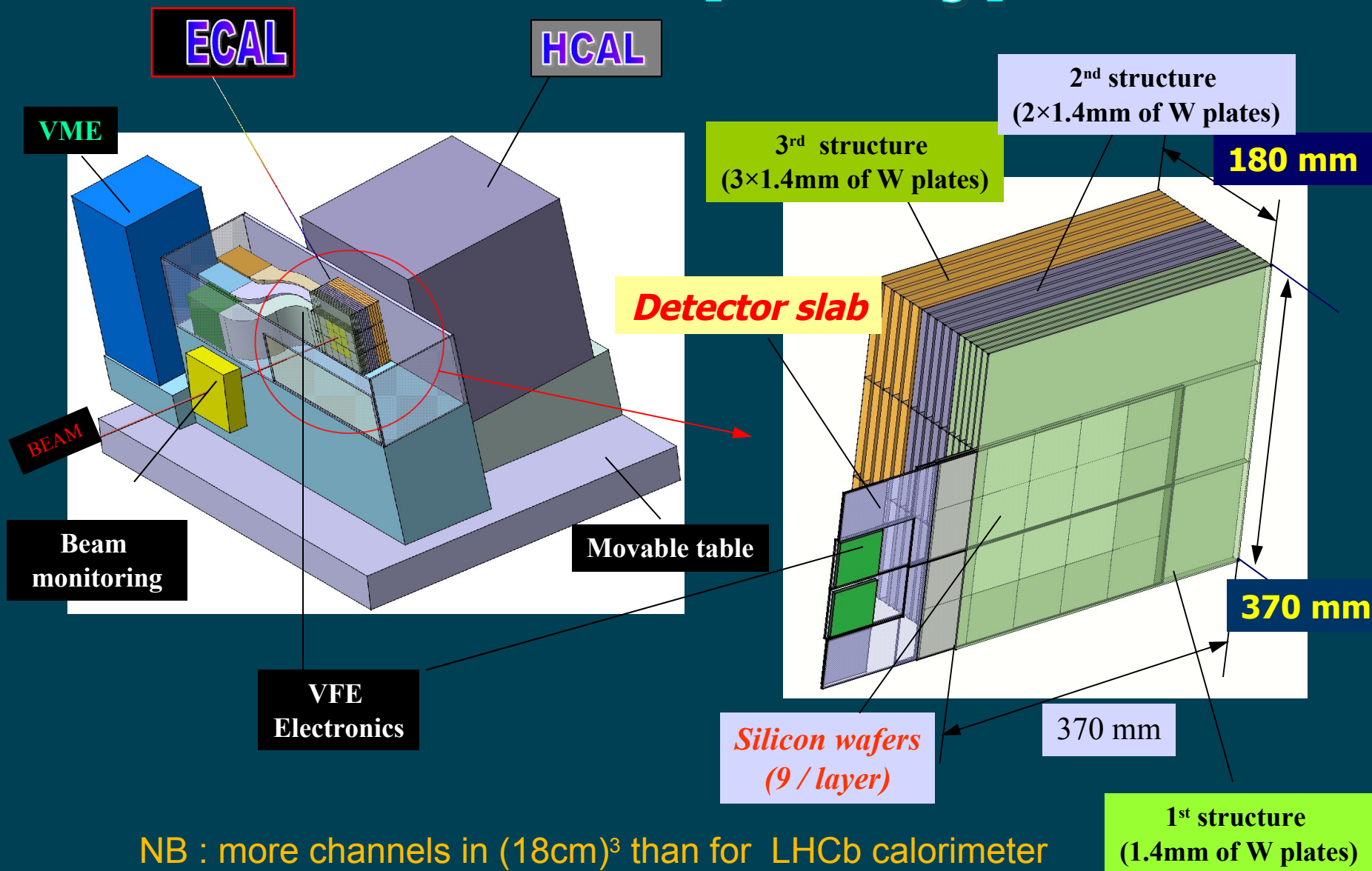
Going to test beam



The physics prototyping. Simulation compared to reality.

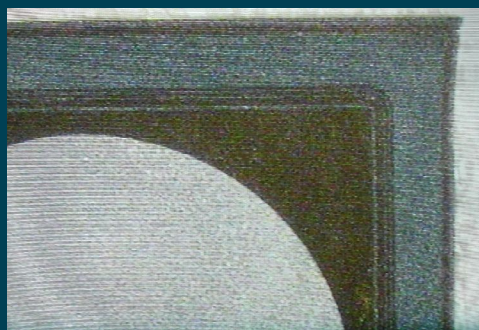
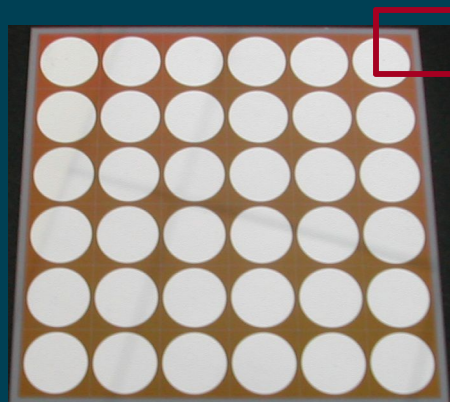
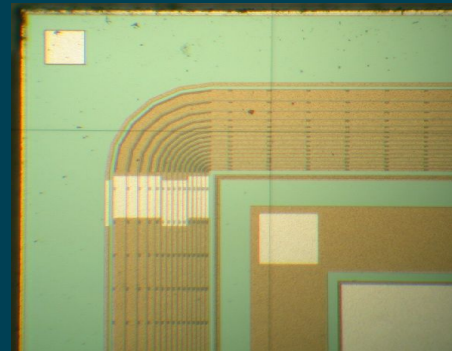
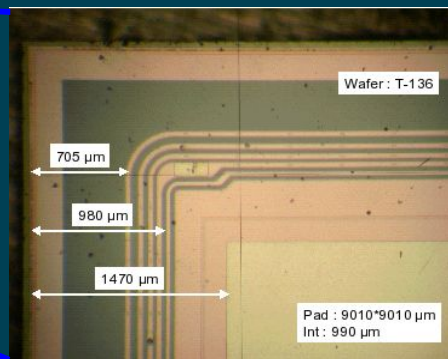
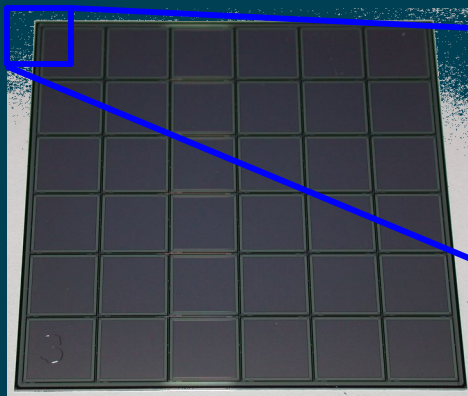
A first approach to technology.

TEST BEAM prototype



NB : more channels in $(18\text{cm})^3$ than for LHCb calorimeter
(or if you prefer CMS, it is 1/8 of the full ECAL)

DETECTOR MATRICES

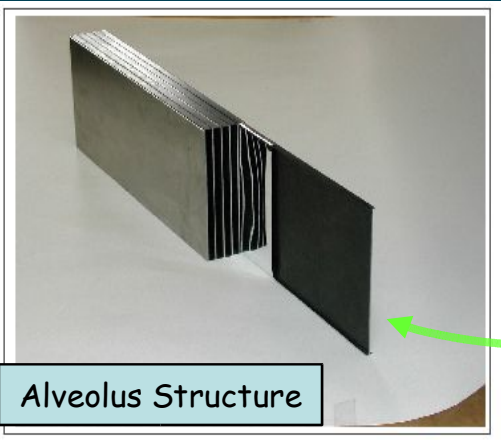


Works with producers
and labs in

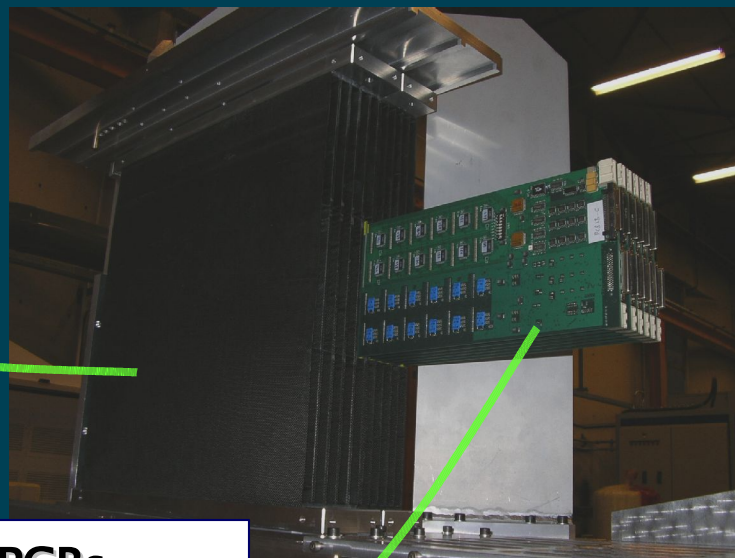
Brazil
Czech republic
India
Japan
Korea
Russia

The diode matrices are the driving cost.

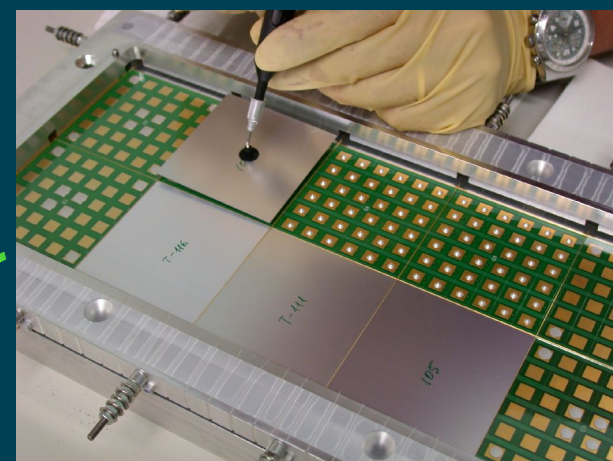
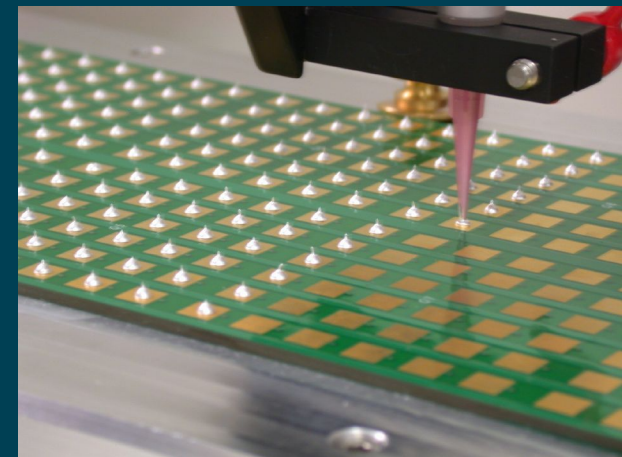
The prototype



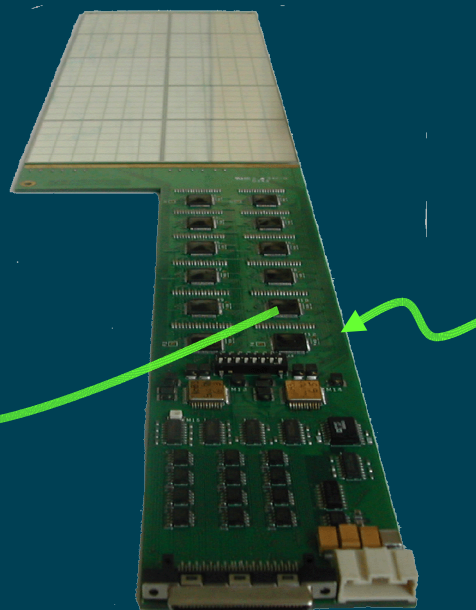
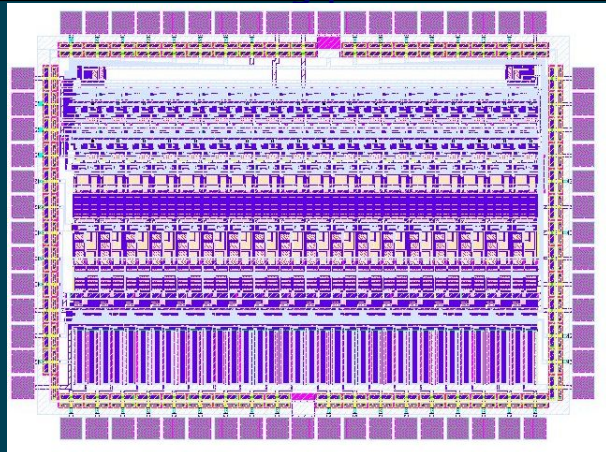
Alveolus Structure



PCBs



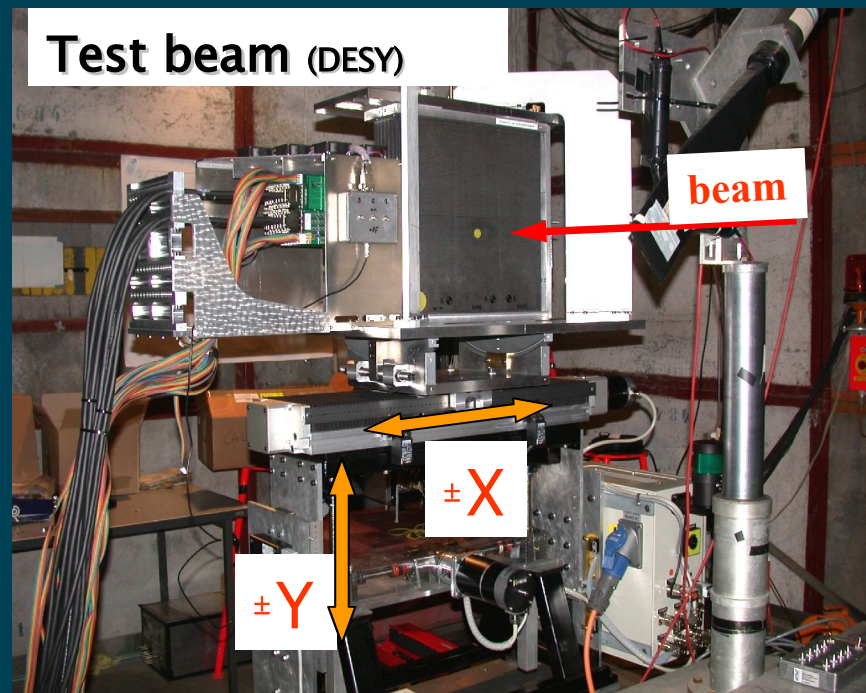
Front-end electronic
analog part



Cosmic test bench (LLR)

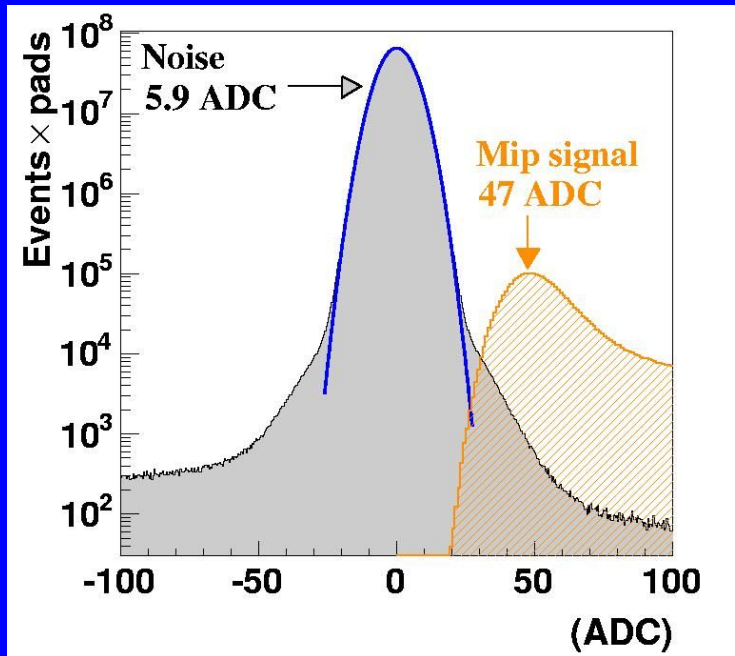


Test beam (DESY)

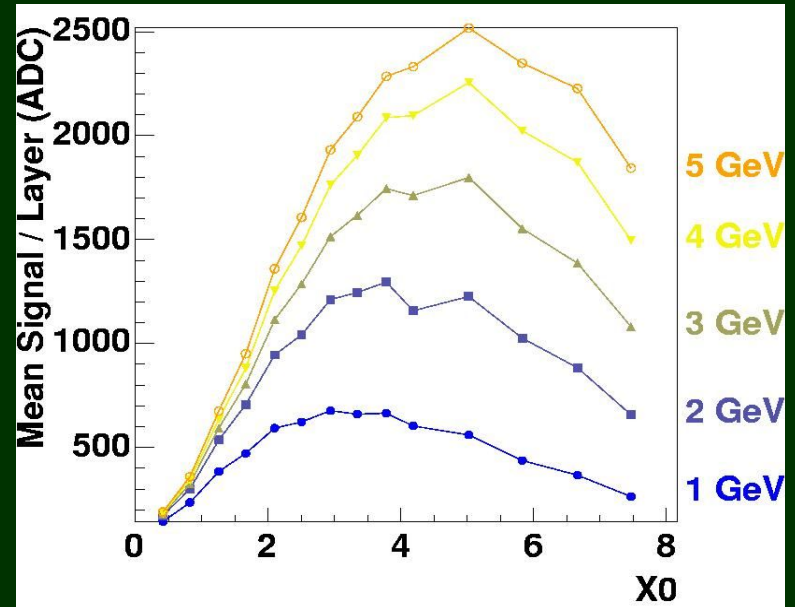
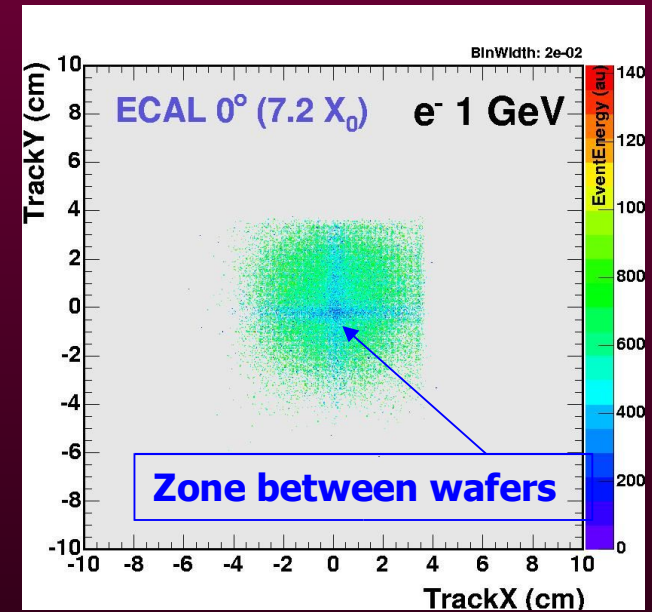


First results of the DESY beam test with ECAL prototype

Recent data still to be analysed



S/N ~ 8 !!



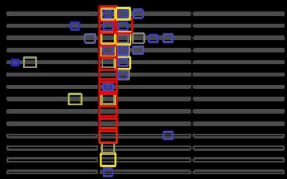
ECAL prototype – first test at DESY (FNAL/CERN 2006...)

CALICE ECAL Prototype

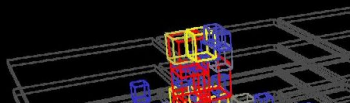
Run=100078

Event= 613

Jan.05

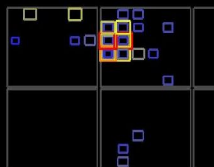


Detector Top

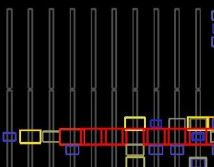


**First real test versus
the « Particle Flow » method
with a dedicated detector**

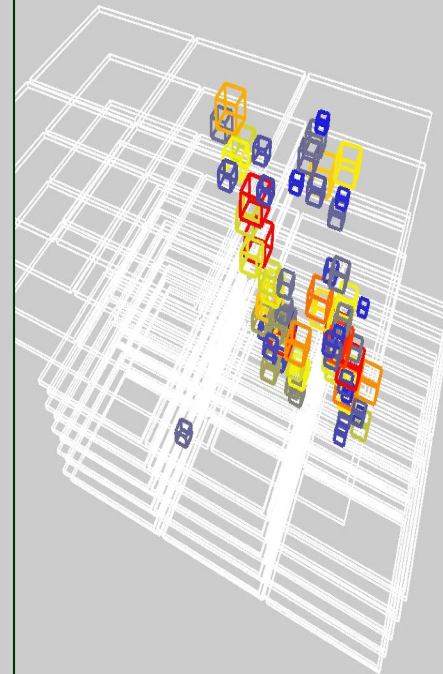
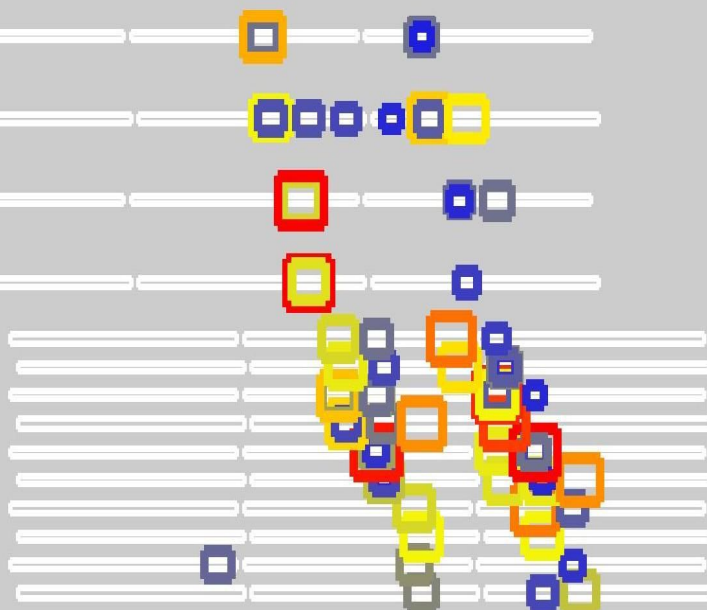
2 close electrons (~ 3cm)



Detector Front



Detector Side

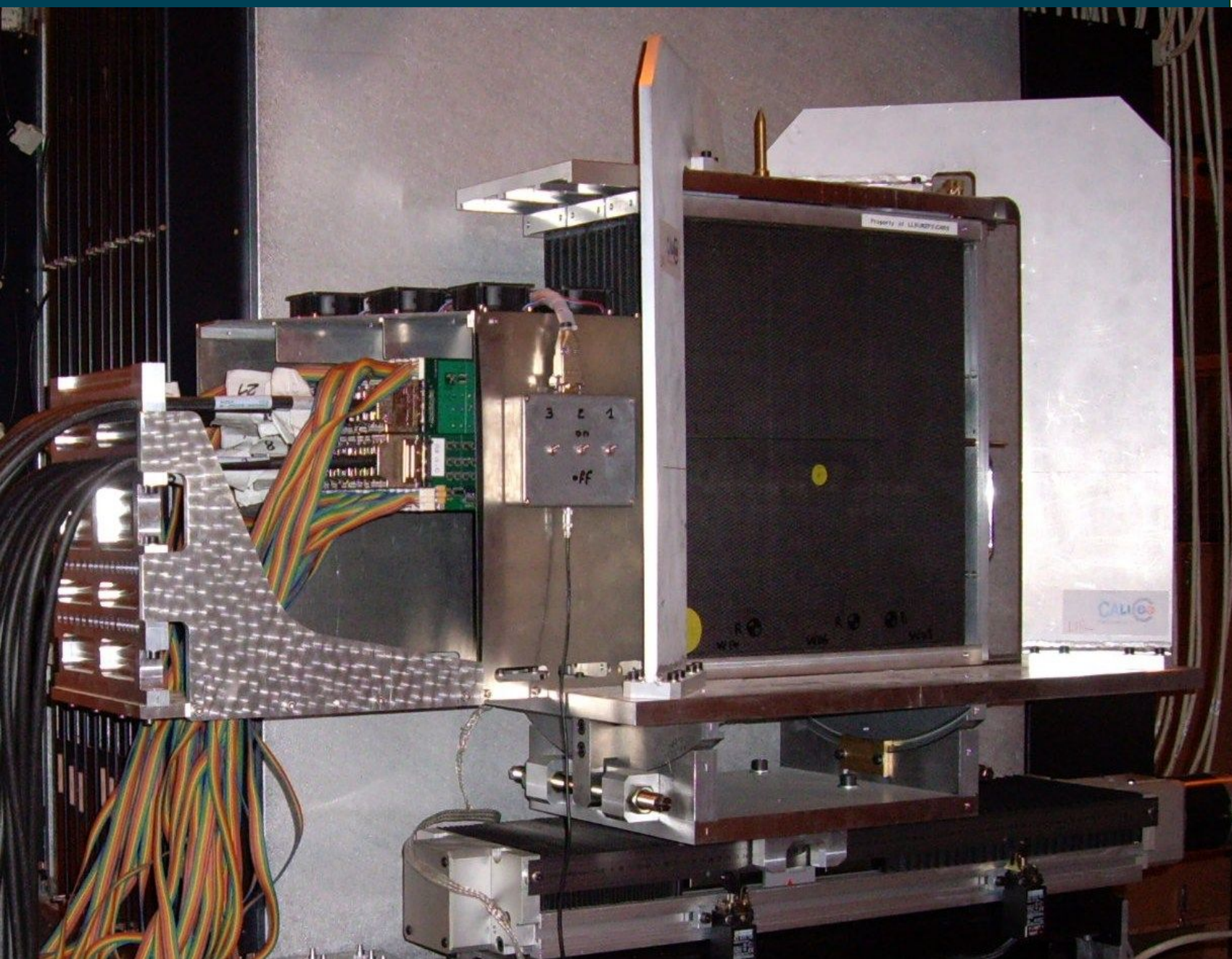


0176 Event 382

**Tail Catcher
(scint.strip-SiPM)**

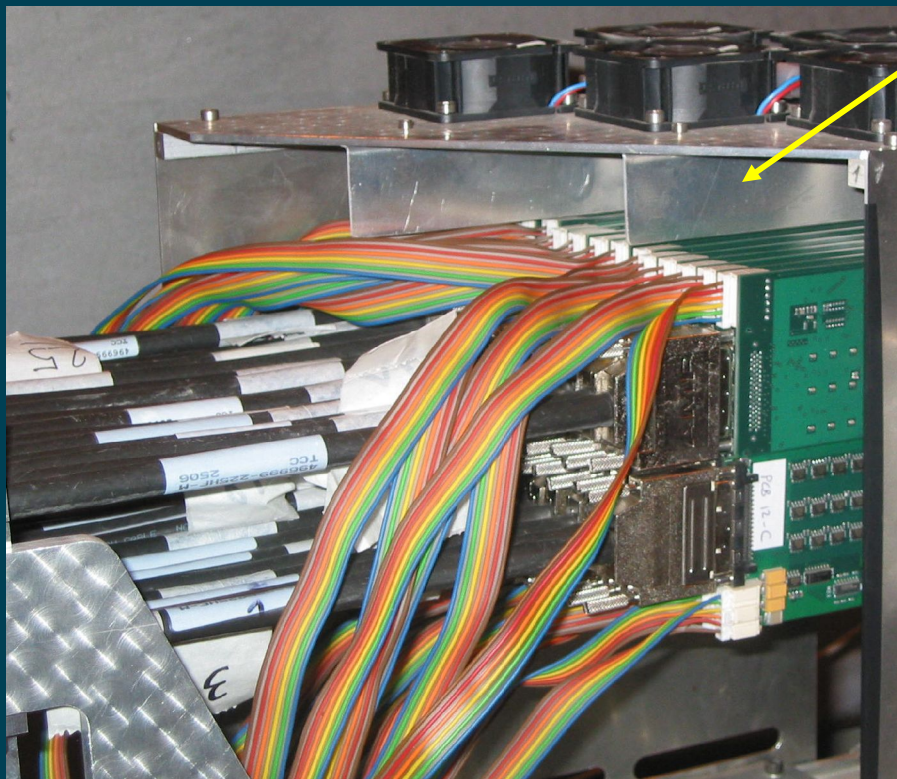
**Tile HCAL
(scint. Tiles-SiPM)**

**ECAL
(W-Si)**

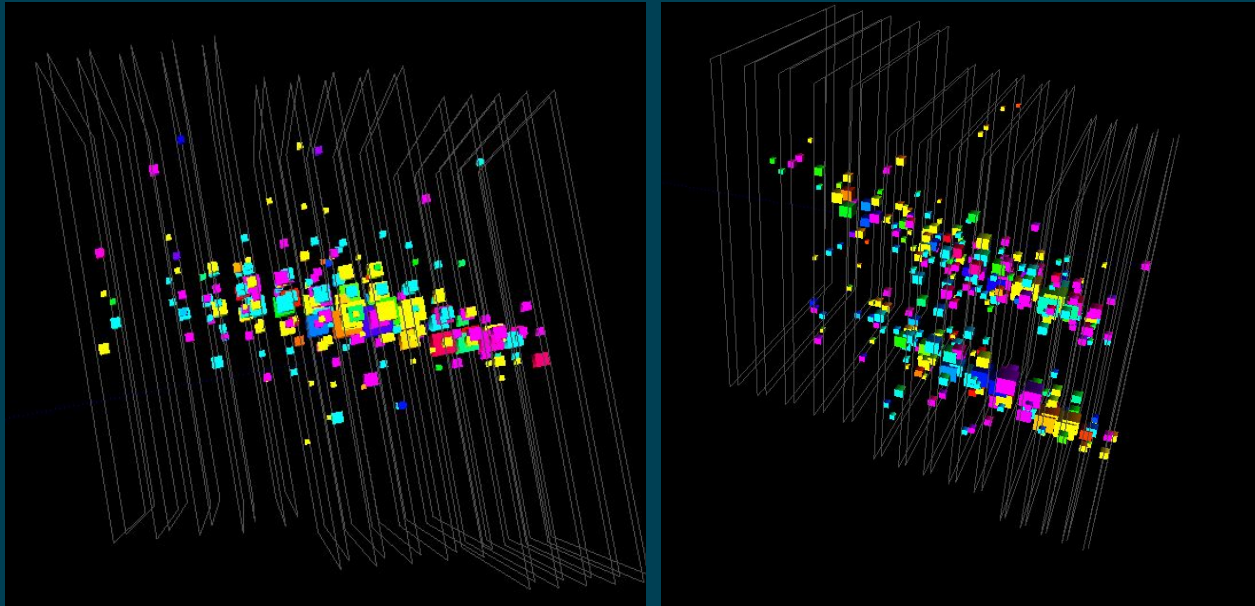


Test at CERN Summer/fall 2006

Test at CERN Summer 2007



For the full scale detector
it is mandatory to change
the design of the device

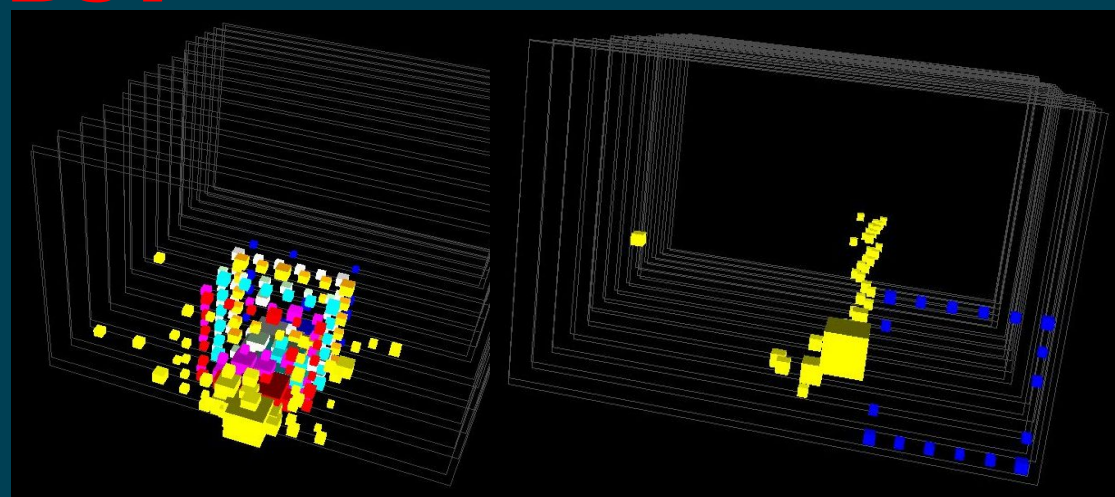


Tests at CERN

GLOBALY, nice performance (see D.Ward)

Effect of dead zones
between wafers

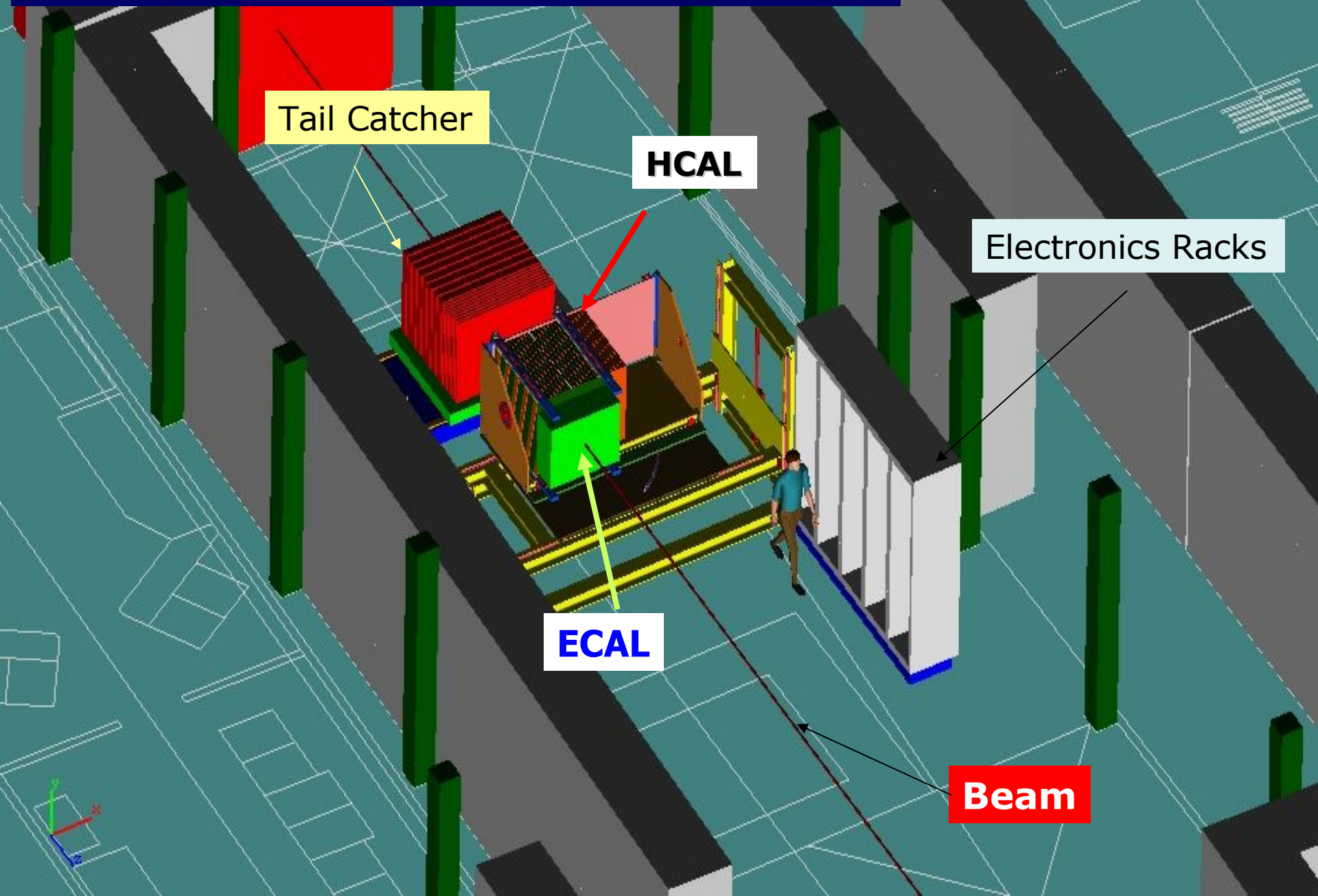
BUT



cross talk effect through
the wafers guard rings

new designs of guard rings
under development.

Possible setup at FNAL MTBF



Next steps

- Test with electrons (may be low energy hadrons)
 - test of running with the **VFE chip INSIDE the detector**
 - Test beam with AHCAL+ECAL for debugging
and ... **single layer test (new design) ...**
CERN 2007 for the W-Si and AHCAL

- Test with hadrons

CERN	Summer 2007
MTBF	From fall 2007

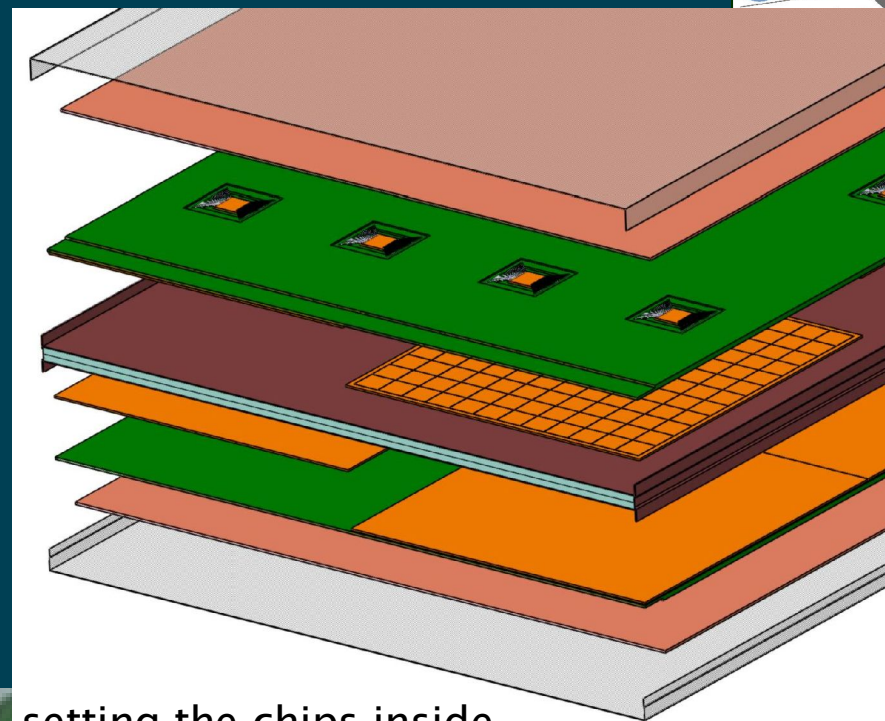
- Toward a second generation of prototypes: Technological models including ½ ECAL final module with all news developments
+ Digital HCAL module + AHCAL + ECAL strip + ...

**2008 – 2010 Second generation prototypes
in test beam FNAL**

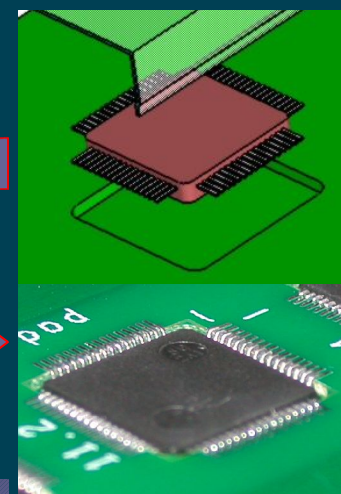
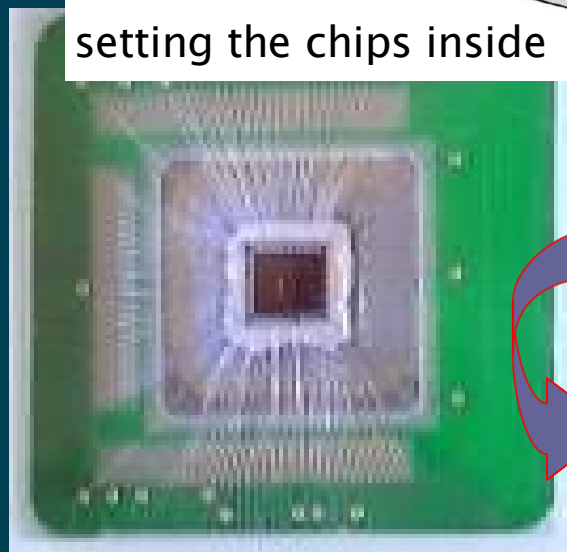
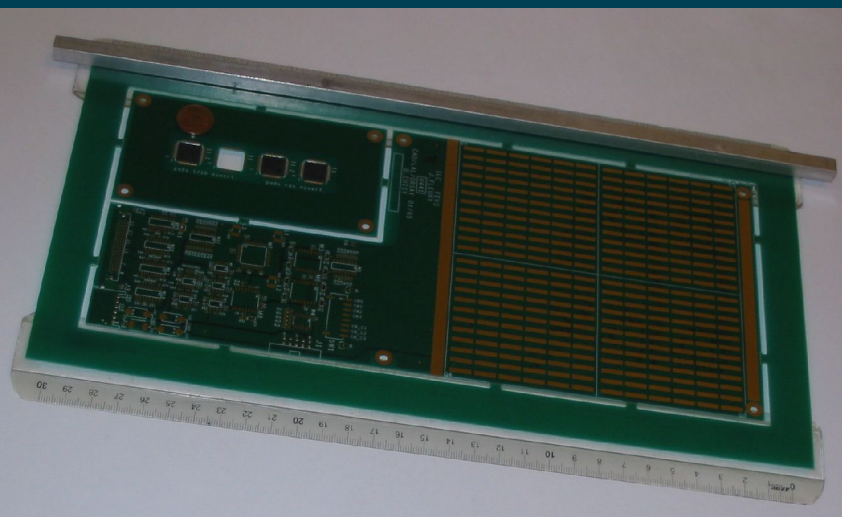
NEW DESIGN

for the ECAL Detector Slab

- Better for mechanical behaviour
- Better Molière radius, thinner
- Better for indust. assembling
- DAQ based on FPGA
- better for VFE
- etc...



setting the chips inside

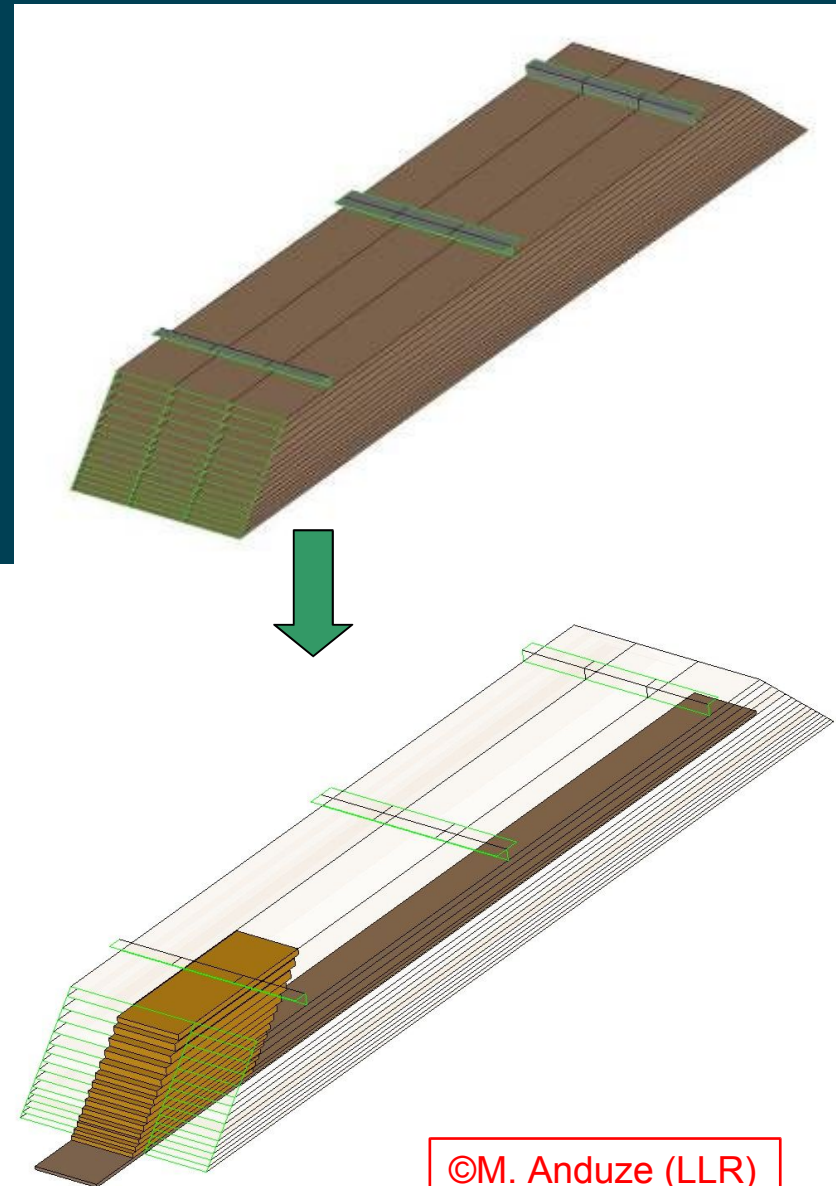


Tested at industrial level



Technological prototype

- Mechanical prototype of a ($\sim 1/2$) module
 - 150 cm long, 3x18 cm wide, 30 layers
 - partially equipped with detector: **one line & one column, $5 \times 5 \text{ mm}^2$ cells**
 - 1800 + 10800 channels
 - Test full scale mechanics + PCB
 - Can go in test beam
 - Test full integration + edge connections
- Similar in channel # to physics prototype



©M. Anduze (LLR)

Using the same structure

The Si diodes can be replaced by MAPS.

A Tera Pixel Calorimeter

The physics is the same, the mechanics as well;

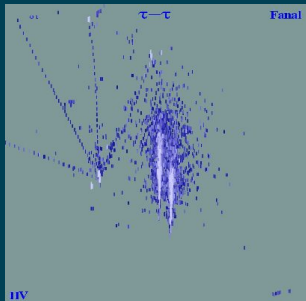
The $5 \times 5 \text{ mm}^2$ cells read analogically are replaced by $50 \times 50 \mu^2$ read digitally.

Do we need to improve on the cell size?

Digital counting improves clearly resolution at low E killing Landau tails.

A way to go digital which may provide a lot of freedom

and could end up being cheaper.

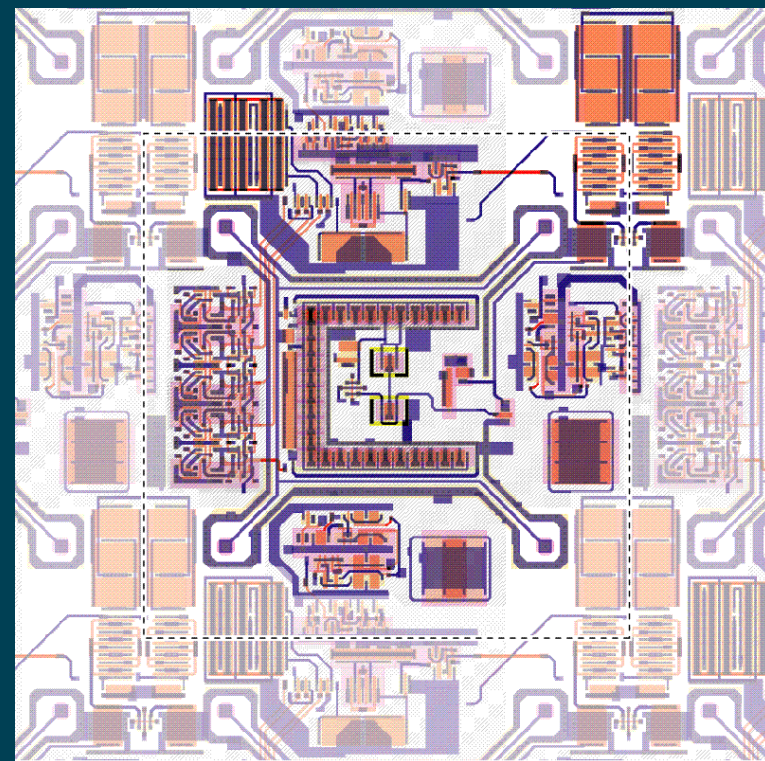
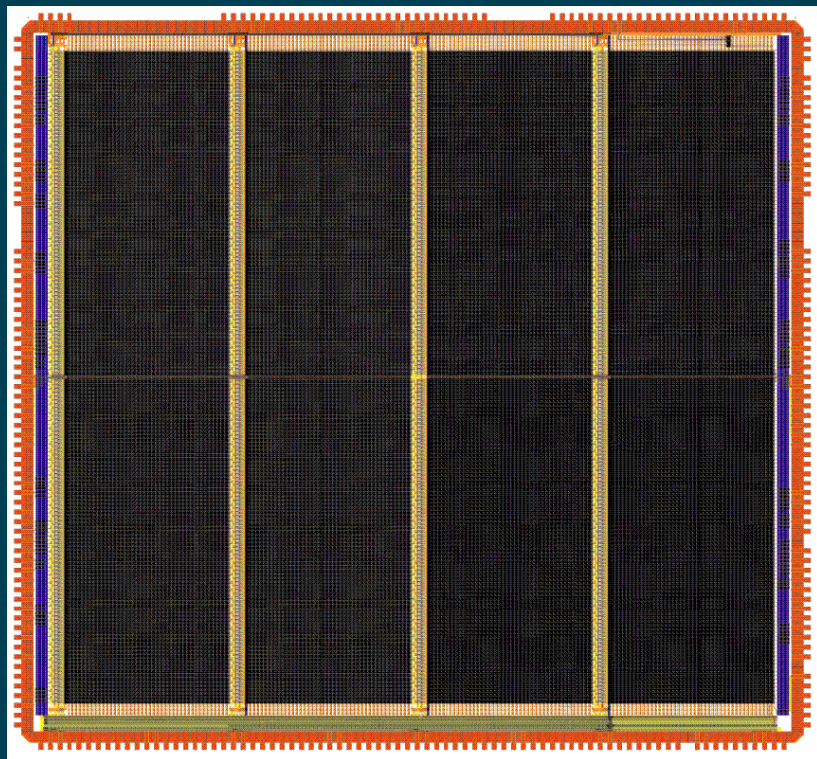


What we need is to know if that works!

Power?

Quick Reminder on MAPS

- Monolithic Active Pixel Sensor : based on CMOS technology, in-pixel comparator and logic.
- Really small for an ECAL, large for a standard MAPS : $50 \times 50 \mu\text{m}^2$ pixels.
- 10^{12} pixels = digital readout.
- Noise objective : probability of 10^{-6} hits above threshold = DAQ has to handle $\sim 10^6$ hits per event! Output will be a simple list of geometrical indices of hits above threshold.
- First design of sensors submitted !! Will be back in July.



Left: Schematic of complete MAPS sensor submitted for fabrication.

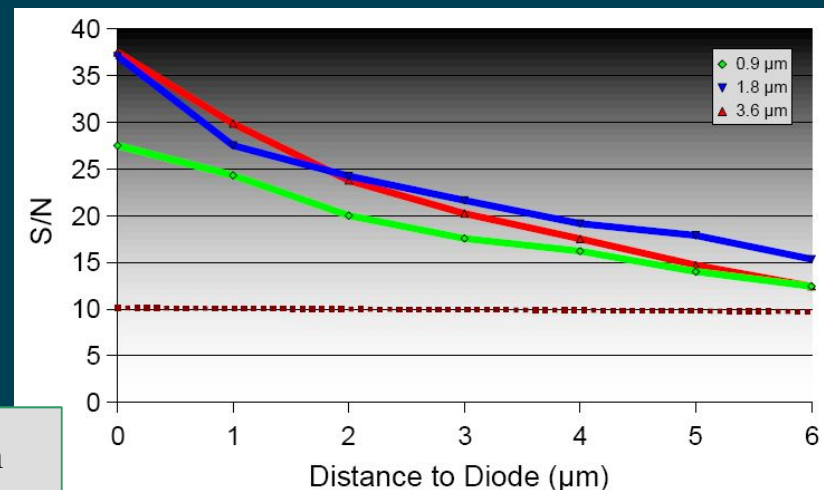
The logic and memory storage areas are clearly visible as the four vertical stripes

Right: Schematic of a pixel layout. The electronics associated with a single pixel is highlighted in colour. The pixel boundary is shown by the dashed line.

Optimisation of some parameters

Signal over noise

- Diode size has been optimised in term of signal over noise ratio, charge collected in the cell in the worst scenario (hit at the corner).
- Diodes place is restricted by the pixels designs, e.g. to minimise capacitance effects



A study has been done on the impact of the threshold applied
still preliminary

When the threshold is set to $\frac{1}{2}$ mip
and a reasonable clustering done on the pixels
the resolution achieved is the same as with large diodes,
the effect of dead zones seems marginal.

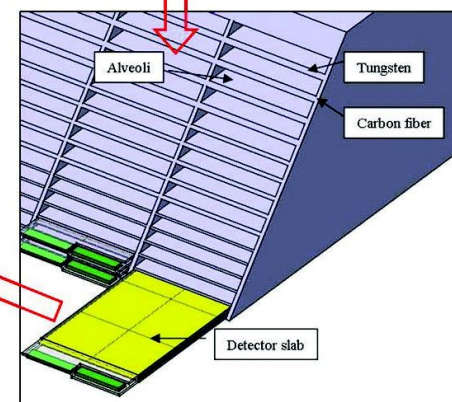
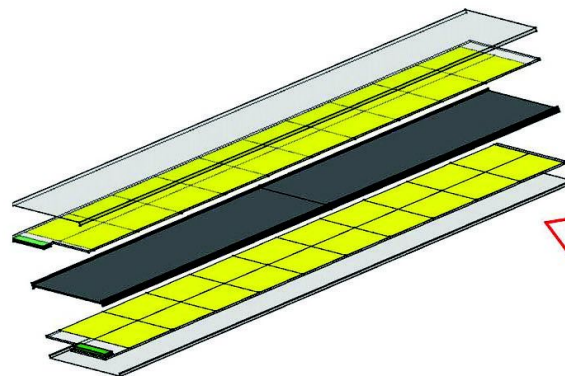
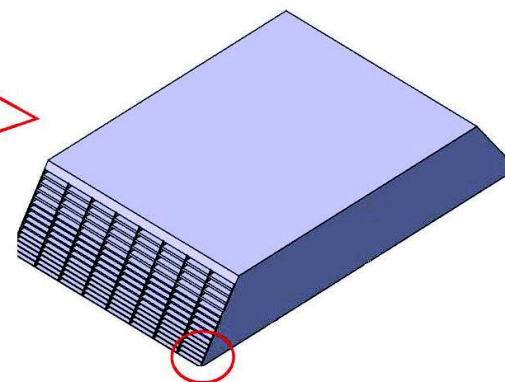
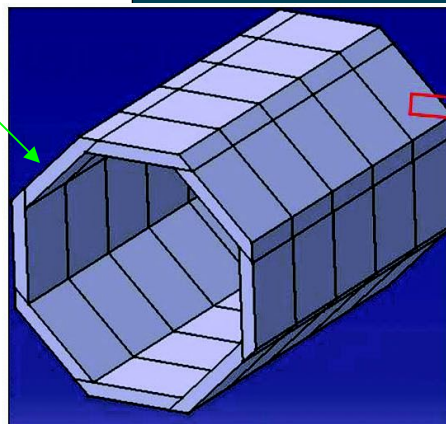
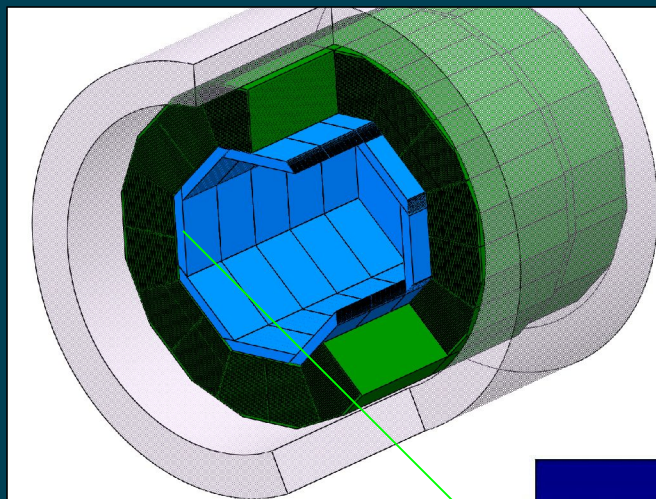
Conclusion

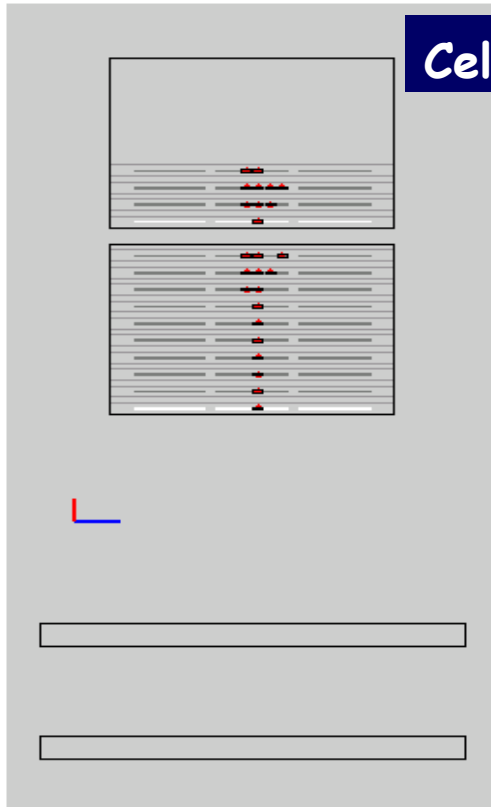
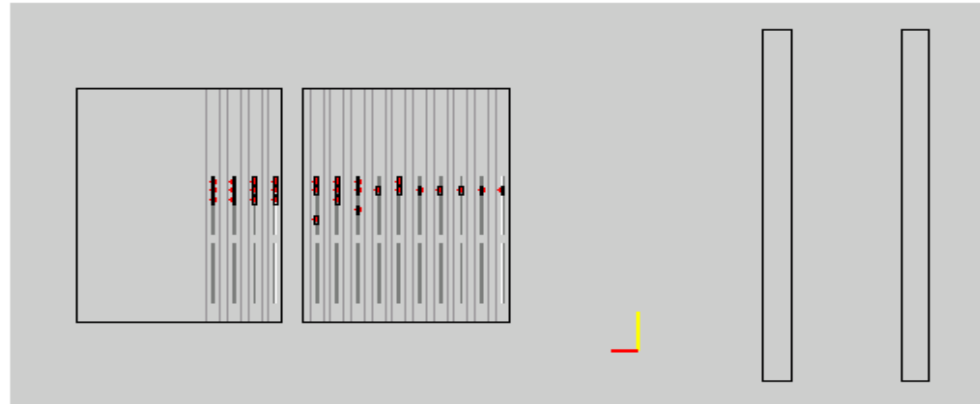
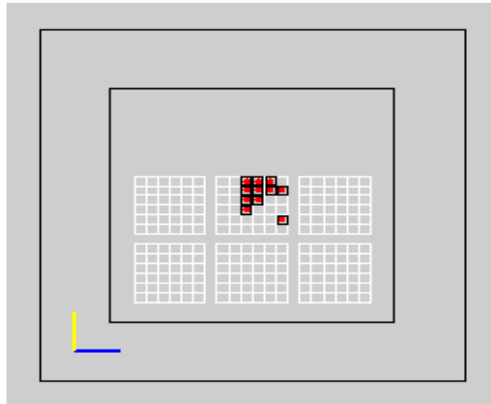
- The W–Si ECAL is one of the options of the CALICE collaboration
- The first prototype, physics, is in test beam and begins to produce interesting results, recycled in technological developments

The second generation, a technological prototype now, is being designed, construction begins soon

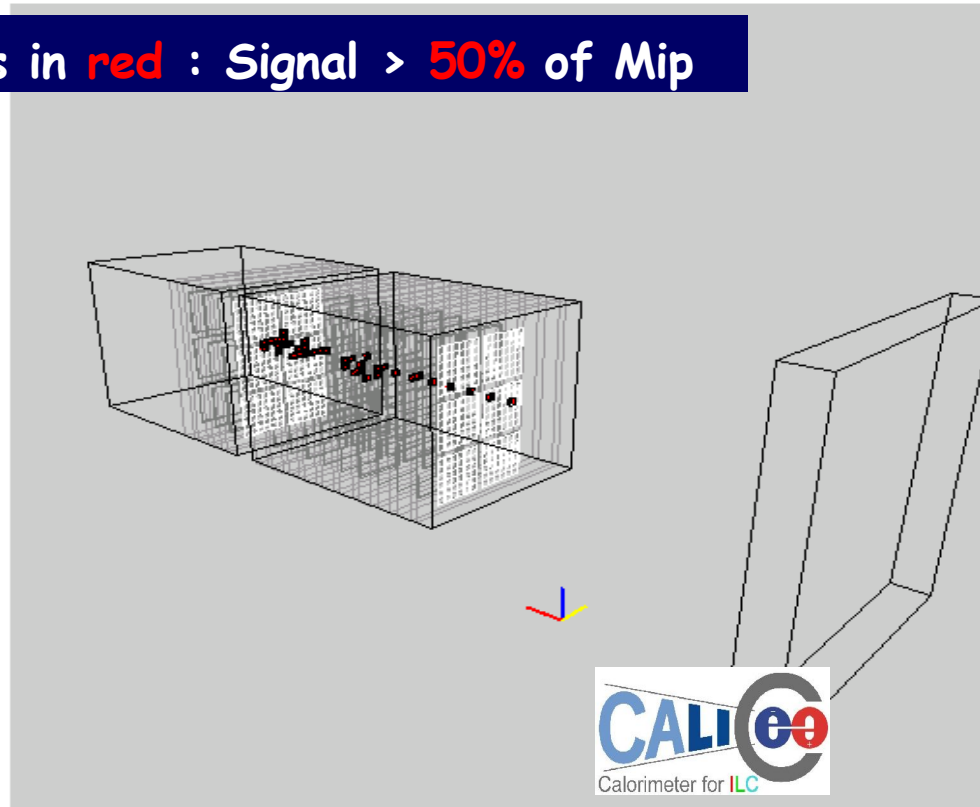
- If all goes well the MAPS will be tested at that stage.

We do not do R&D for fun along flowing years
but try to address in a coherent and rigorous mind
what we think are the ILC calorimetry challenges
in the timetable of the accelerator.





Cells in red : Signal > 50% of Mip



Results on the energy resolution vs threshold after each step

VERY PRELIMINARY

$\sigma(E)/E$ vs Threshold, electron 20 GeV

